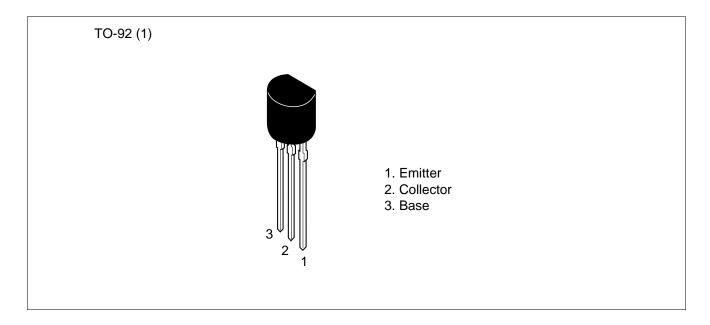
Silicon PNP Epitaxial

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Application

- Low frequency low noise amplifier
- Complementary pair with 2SC2545, 2SC2546 and 2SC2547

Outline



Absolute Maximum Ratings (Ta = 25°C)

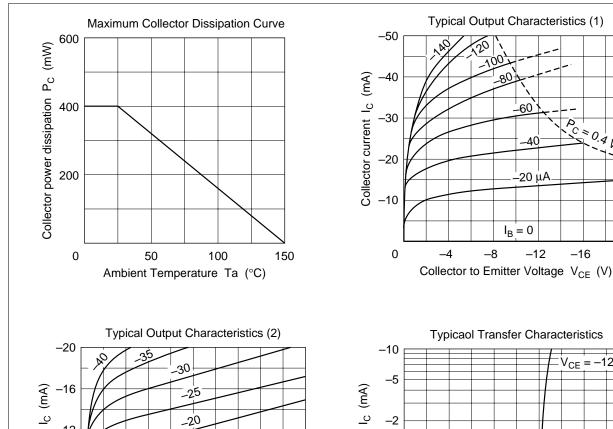
Item	Symbol	2SA1083	2SA1084	2SA1085	Unit
Collector to base voltage	V_{CBO}	-60	- 90	-120	V
Collector to emitter voltage	V_{CEO}	-60	- 90	-120	V
Emitter to base voltage	V_{EBO}	– 5	- 5	- 5	V
Collector current	I _c	-100	-100	-100	mA
Emitter current	I _E	100	100	100	mA
Collector power dissipation	P _c	400	400	400	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

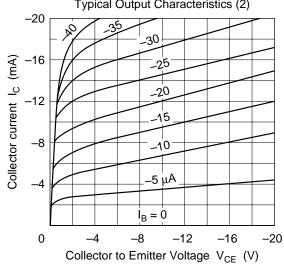
Electrical Characteristics $(Ta = 25^{\circ}C)$

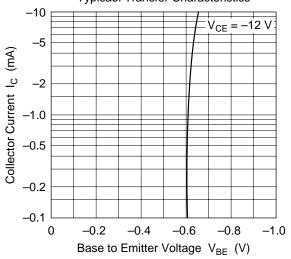
		2SA1	083		2SA1084		2SA1085					
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V _{(BR)CBO}	-60	_	_	-90	_	_	-120	_	_	V	$I_{C} = -10 \ \mu\text{A}, \ I_{E} = 0$
Collector to emitter breakdown voltage	V _{(BR)CEO}	-60	_	_	-90	_	_	-120	_	_	V	$I_C = -1 \text{ mA},$ $R_{BE} = \infty$
Emitter to base breakdown voltage	V _{(BR)EBO}	- 5	_	_	- 5	_	_	- 5	_	_	V	$I_E = -10 \mu\text{A}, \ I_C = 0$
Collector cutoff current	I _{CBO}	_	_	-0.1	_	_	-0.1	_	_	-0.1	μΑ	$V_{CB} = -50 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_	_	-0.1	_	_	-0.1	_	_	-0.1	μΑ	$V_{EB} = -2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h _{FE} *1	250	_	800	250	_	800	250	_	800		$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	V _{CE(sat)}	_	_	-0.2	_	_	-0.2	_	_	-0.2	V	$I_{C} = -10 \text{ mA},$ $I_{B} = -1 \text{ mA}$
Base to emitter voltage	V_{BE}	_	-0.6	_	_	-0.6	_	_	-0.6	_	V	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Gain bandwidth product	f _T	_	90	_	_	90	_	_	90	_	MHz	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector output capacitance	Cob	_	3.5	_	_	3.5	_	_	3.5	_	pF	$V_{CB} = -10 \text{ V}, I_{E} = 0,$ f = 1 MHz
Noise voltage reffered to input	e _n	_	0.5	_	_	0.5	_	_	0.5	_	nV/ √ Hz	$V_{CE} = -6V$, $I_C = -10 \text{ mA}$, f = 1 kHz, $R_g = 0$, $\Delta f = 1 \text{Hz}$

Note: 1. The 2SA1083, 2SA1084 and 2SA1085 are grouped by $h_{\rm FE}$ as follows.

D	E
250 to 500	400 to 800



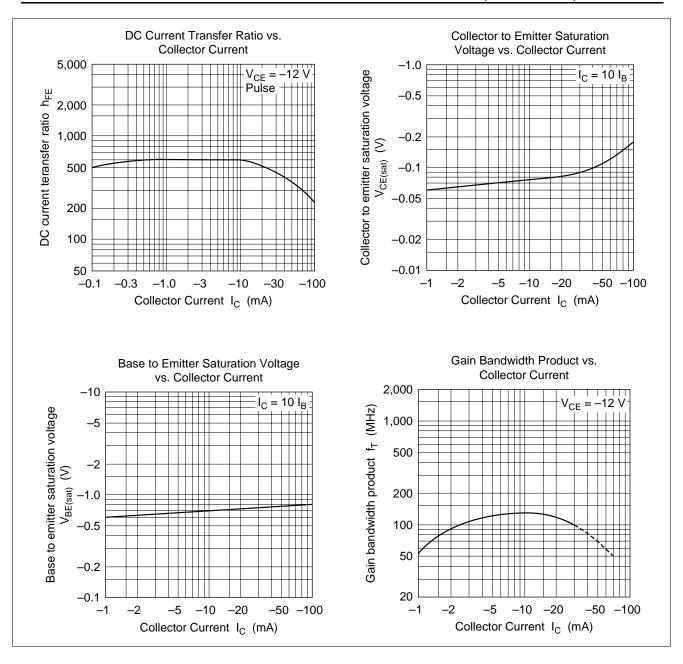


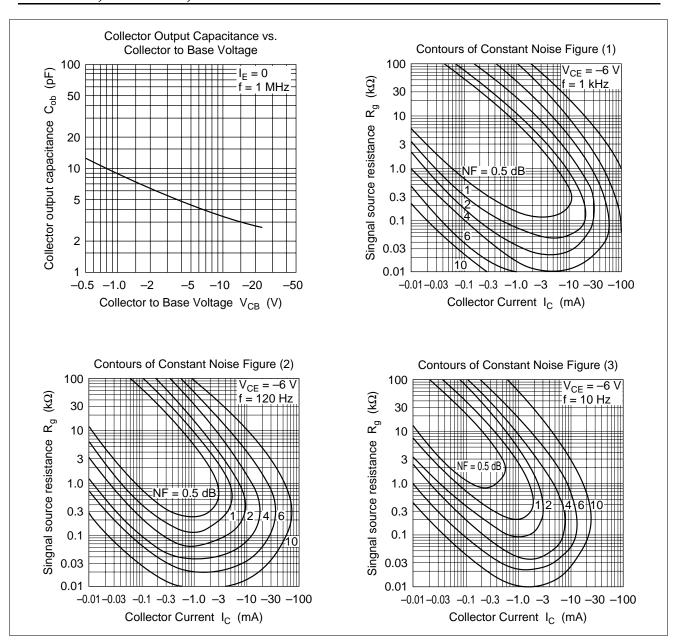


PC = 0.4 W

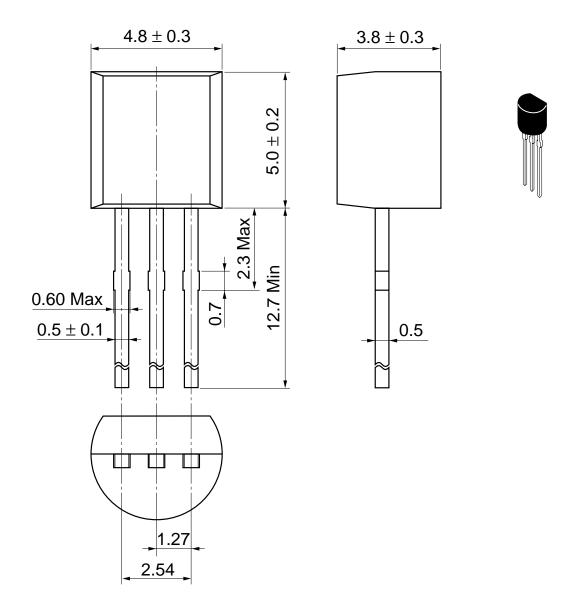
-16

-20





Unit: mm



Hitachi Code	TO-92 (1)
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.25 g

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